

400mW SOD-123 SURFACE MOUNT Small Outline Gull Wing Lead Plastic Package General Purpose Application Fast Switching Diode

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
PD	Power Dissipation	400	mW	
T _{STG}	Storage Temperature Range	-65 to +150	°C	
TJ	Operating Junction Temperature	+150	°C	
V _{RSM}	Non-Repetitive Peak Reverse Voltage	100	V	
V _{RRM}	Repetitive Peak Reverse Voltage	75	V	
I _{FRM}	Repetitive Peak Forward Current	300	mA	
lo	Continuous Forward Current	150	mA	
I _{FSM}	Peak Forward Surge Current (Pulse Width=1us)	2	А	

These ratings are limiting values above which the serviceability of the diode may be impaired.

Specification Features:

- Fast Switching Device (T_{RR} <4.0 nS)
- General Purpose Diodes
- Gull Wing Lead SOD-123 Small Outline Plastic Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode
- Weight: approx. 0.01g

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

0	Parameter		Test Canditian	Limits		11-24
Symbol			Test Condition	Min	Max	Unit Nax
Bv	Breakdown Voltage		I _R =100μΑ	100		Valta
			I _R =5μΑ	75	Volts	
I _R	Reverse Leakage Current		V _R =20V		25	nA
			V _R =75V		5	μA
VF	Forward Voltage	1N4448WG	I _F =5mA	0.62	0.72	
		1N4148WG	I _F =10mA		1.0	Volts
		1N4448WG	I _F =100mA		1.0	
T _{RR}	Reverse Recovery Time		I _F =10mA			
			I _R =60mA			
			R _L =100Ω		4	nS
			I _{RR} =1mA			
С	Capacitance		V _R =0V, f=1M _{HZ}		4	pF

SEMICONDUCTOR

Green Product



SOD-123 Gull Wing Lead



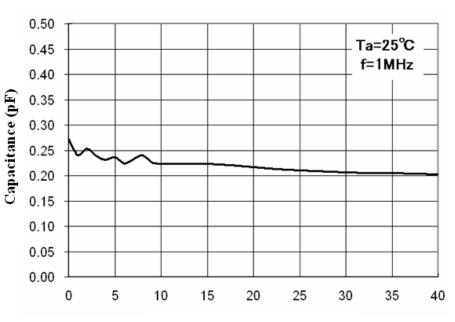
ELECTRICAL SYMBOL

DEVICE MARKING CODE:

Device Type	Device Marking
1N4148WG	T4
1N4448WG	T5

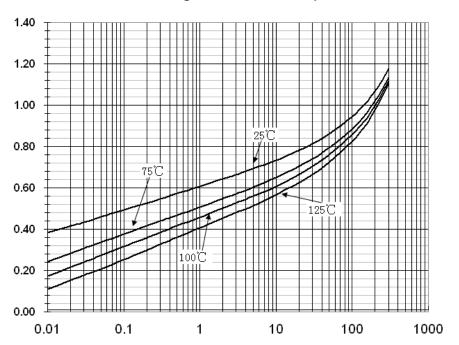


Typical Performance Characteristics



Total Capacitance

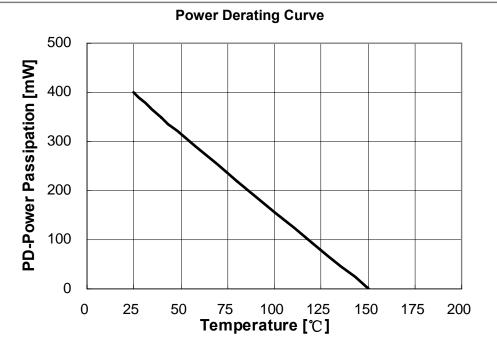
Reverse Voltage (V)

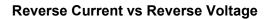


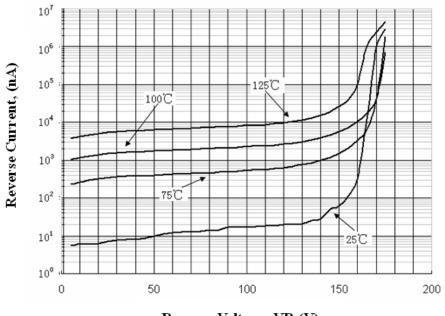
Forward Voltage vs Ambient Temperature



SEMICONDUCTOR





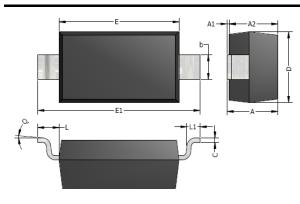


Reverse Voltage, VR (V)

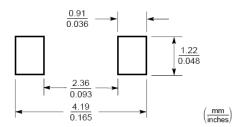


SEMICONDUCTOR

SOD123 Gull Wing Lead Package Outline



Typical Soldering Pattern:



DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
Α	1.05	1.25	0.041	0.049	
A1	0.00	0.10	0.000	0.004	
A2	1.05	1.15	0.041	0.045	
b	0.50	0.70	0.020	0.028	
с	0.08	0.15	0.003	0.006	
D	1.50	1.70	0.059	0.067	
Е	2.60	2.80	0.102	0.110	
E1	3.55	3.85	0.140	0.152	
L	0.50 REF.		0.020 REF.		
L1	0.25	0.45	0.010	0.018	
θ	O ⁰	8 °	0 °	8 °	

Note:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



NOTICE

The information presented in this document is for reference only. Tak Cheong reserves the right to make changes without notice for the specification of the products displayed herein.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Tak Cheong Semiconductor Co., Ltd., or anyone on its behalf, assumes no responsibility or liability for any damagers resulting from such improper use of sale.

This publication supersedes & replaces all information reviously supplied. For additional information, please visit our website <u>http://www.takcheong.com</u>, or consult your nearest Tak Cheong's sales office for further assistance.